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N-Channel PowerTrench[®] MOSFET 30 V, 131 A, 2.5 m Ω

Features

- Max $r_{DS(on)} = 2.5 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$
- Max $r_{DS(on)}$ = 3.6 m Ω at V_{GS} = 4.5 V, I_D = 21.5 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

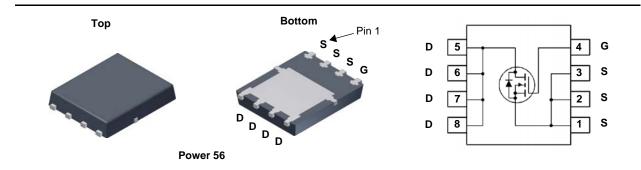


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed ang body diode reverse recovery performance.

Applications

- VRM Vcore Switching For Desktop And Server
- OringFET / Load Switching
- DC-DC Conversion
- Motor Bridge Switch



MOSFET Maximum Ratings $T_A = 25$ °C unless otherwise noted.

Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 6)	131		
	-Continuous	T _C = 100 °C	(Note 6)	83		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	26	— A	
	-Pulsed		(Note 5)	507		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	93	mJ	
D	Power Dissipation	T _C = 25 °C		65	14/	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance, Junction-to-Case	1.9	°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient (Note 1a) 50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8020	FDMS8020	Power 56	13 "	12 mm	3000 units

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May 2015

Units	FDMS8020
V	0 7
mV/°C	N-Channel
μΑ	าล
μA nA	nn
	el P
V	NO N
mV/°C	/erT
mΩ	PowerTrench
S	
	NOS
pF	Ϊ
nF	1 11

BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$				V
ΔΒV _{DSS} ΔΤ _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
I _{GSS}	Gate to Source Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
On Char	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.5	3.0	V
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-6		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 26 A	V, I _D = 26 A		2.5	mΩ
		V _{GS} = 4.5 V, I _D = 21.5 A		2.6	3.6	
		V _{GS} = 10 V, I _D = 26 A, T _J = 125 °C		2.9	3.7	1
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 26 A		154		S
Dynamic C _{iss}	Characteristics			2855	3800	pF
C _{iss} C _{oss}	Output Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$		1050	1400	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		115	175	pF
R _g	Gate Resistance			0.9		ρ. Ω
Switchin	g Characteristics					
t _{d(on)}	Turn-On Delay Time			12	22	ns
t _r	Rise Time	V _{DD} = 15 V, I _D = 26 A,		5.7	12	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		32	52	ns
t _f	Fall Time			4	10	ns
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		43	61	nC
Q _q	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 15 V$, $I_D = 26 A$		21	29	nC
y	Onto the One way of a way	In = 26 A		7.3		nC
Q _{gs}	Gate to Source Charge	10 = 20 / 1		1.0		

Test Conditions

Min

Тур

Max

Drain-Source Diode Characteristics

Electrical Characteristics T_J = 25 °C unless otherwise noted.

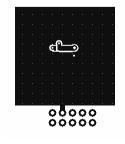
Parameter

V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2.1 A$	(Note 2)	0.6	68 1.	1	V
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 26 A$	(Note 2)	0.7	'8 1.	2	v
t _{rr}	Reverse Recovery Time	I _F = 26 A, di/dt = 100 A/μs		37	7 5	8	ns
Q _{rr}	Reverse Recovery Charge			18	3 3	3	nC
t _{rr}	Reverse Recovery Time	I _F = 26 A, di/dt = 300 A/μs		30) 4	8	ns
Q _{rr}	Reverse Recovery Charge			36	6 5 [.]	7	nC

Notes:

Symbol

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design.



a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

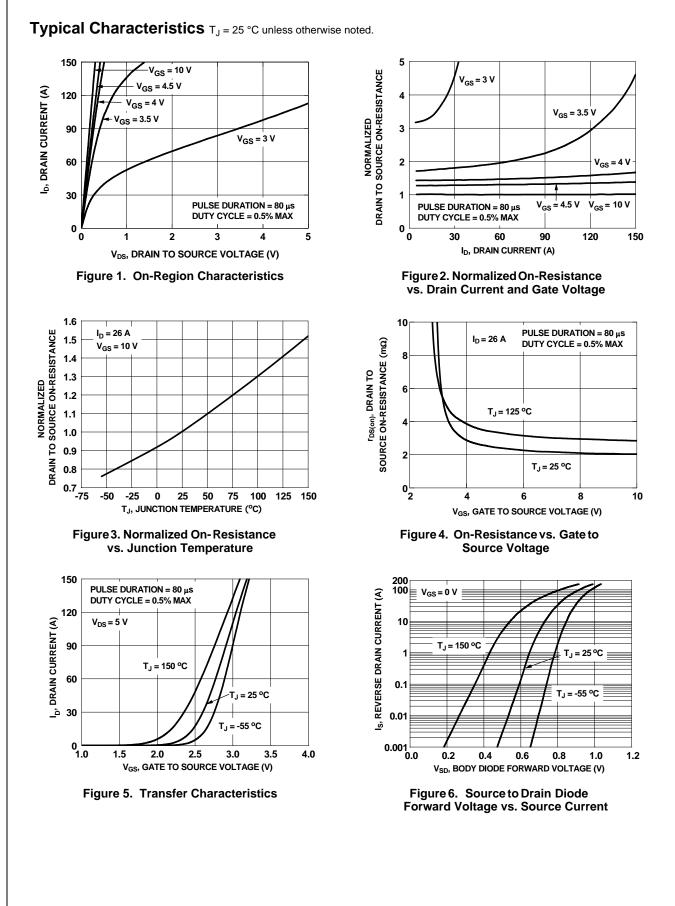
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T_J = 25 °C; N-ch: L = 0.3 mH, I_{AS} = 25 A, V_{DD} = 27 V, V_{GS} = 10 V.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

5. Pulsed Id please refer to SOA curve for more details.

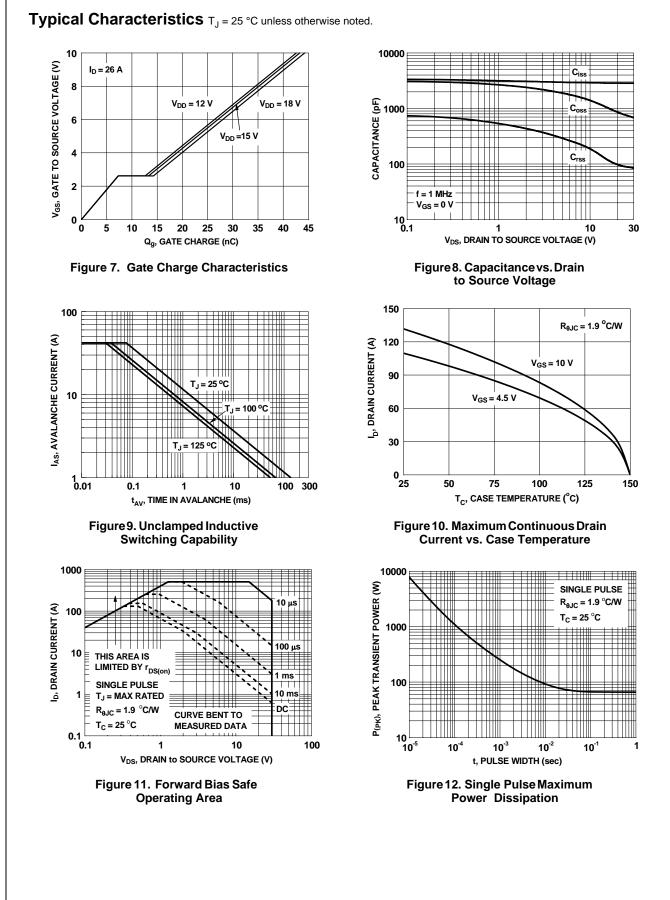
6. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

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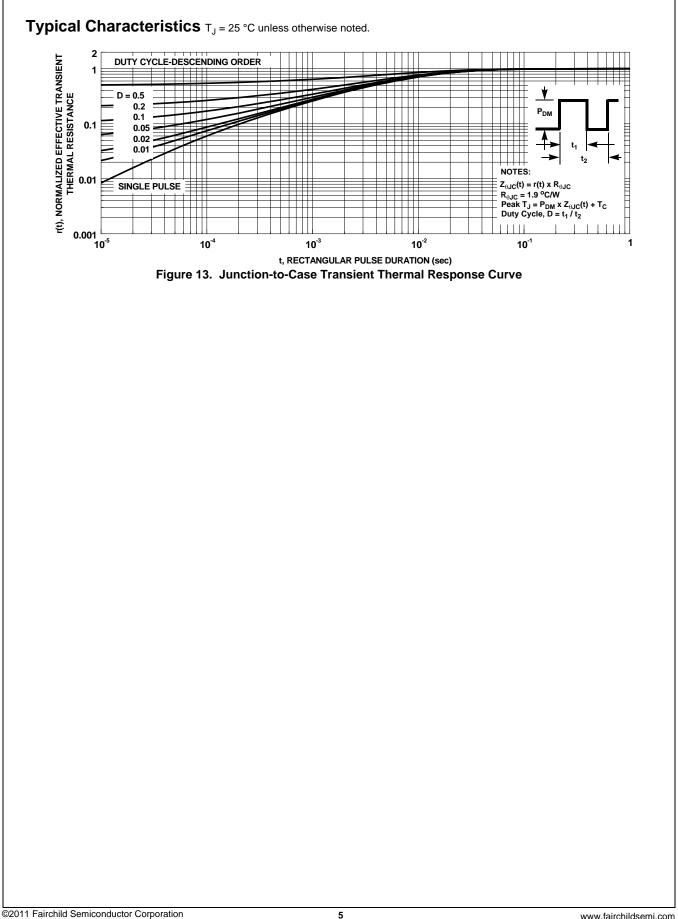


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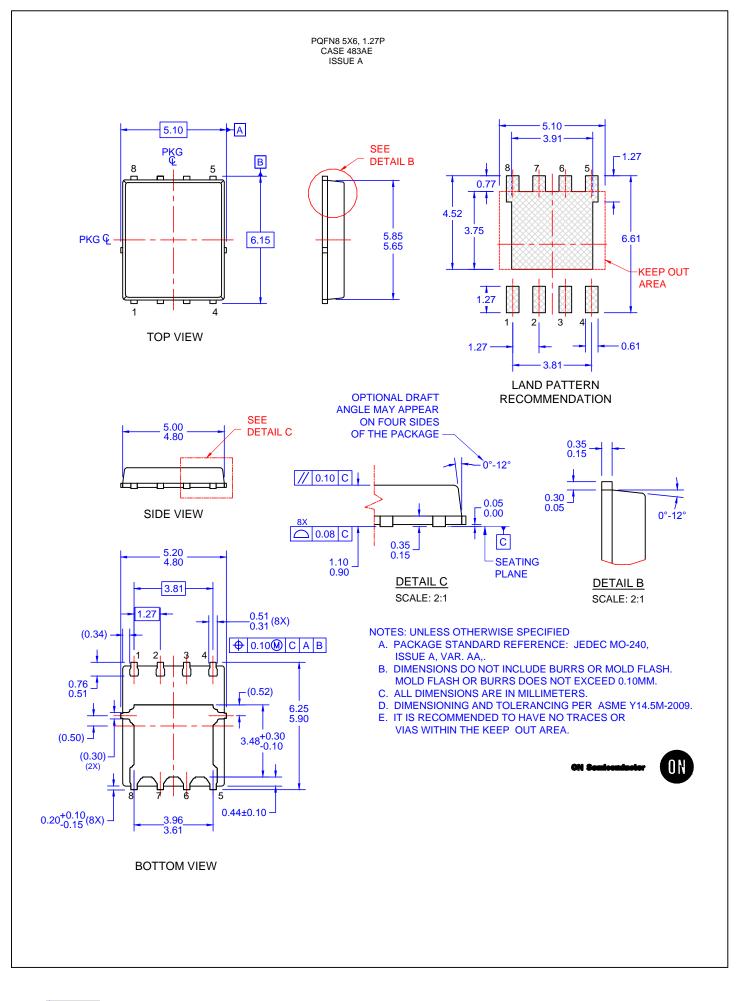




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FDMS8020 N-Channel PowerTrench[®] MOSFET



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